

# TPUL2T323 Dual Retriggerable Extended RC-Timed Monostable Multivibrators

#### 1 Features

- RC configurable from 10ms to 880s
- Extended pulse width functionality reduces capacitor value required for long pulse widths by factor of 1000
- For pulses less than 10ms, use
- 1% typical, 10% maximum pulse width variation
- Wide operating range of 1.5V to 5.5V
- Inputs accept voltages up to 5.5V
- TTL-compatible with 4.5V to 5.5V supply
- Schmitt-trigger architecture on all inputs
- Single-supply voltage translator (refer to Reduced Input Threshold Voltage):
  - Up translation:
    - 1.2V to 1.8V
    - 1.5V to 2.5V
    - 1.8V to 3.3V
    - 3.3V to 5.0V
  - Down translation:
    - 5.0V, 3.3V, 2.5V to 1.8V
    - 5.0V, 3.3V to 2.5V
    - 5.0V to 3.3V

## 2 Applications

- Demodulate a digital Amplitude Shift Keying (ASK)
- Reset a system for a fixed period of time
- Generate a positive fixed-width digital pulse
- Detect a digital signal rising edge
- Detect a digital signal falling edge
- Debounce a switch

## 3 Description

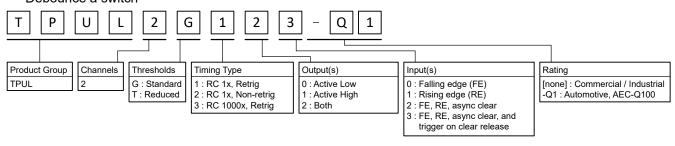
The TPUL2T323 device contains two independent extended-pulse-width RC-configurable retriggerable monostable multivibrators designed for 1.5V to 5.5V operation. The output pulse duration is configured by selecting external resistance and capacitance values with an approximate output pulse width of  $t_{wo} \approx 1000$ 

This device features three inputs, allowing for rising edge (T) and falling edge ( $\overline{T}$ ) triggers and a clear input (CLR) that can be used asynchronously to stop an active output pulse. All inputs include Schmitt-trigger architecture to allow for slow input transition rates and improve noise immunity.

### **Device Information**

PART	PACKAGE (1)	PACKAGE	BODY
NUMBER		SIZE <sup>(2)</sup>	SIZE
TPUL2T323	PW (TSSOP, 16)	5mm × 6.4mm	5mm × 4.4mm

- For all available packages, see the orderable addendum at the end of the data sheet.
- The package size (length × width) is a nominal value and includes pins, where applicable.



**TPUL Family Naming Convention** 



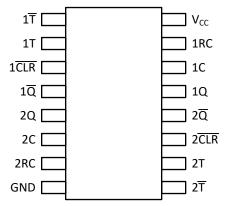
# **Table of Contents**

1 Features	7.4
2 Applications1	8 Ap
3 Description1	8.1
4 Pin Configuration and Functions3	8.2
5 Specifications4	8.3
5.1 Absolute Maximum Ratings4	8.4
5.2 ESD Ratings4	8.5
5.3 Recommended Operating Conditions5	9 De
5.4 Thermal Information5	9.1
5.5 Electrical Characteristics6	9.2
5.6 Timing Characteristics7	9.3
5.7 Switching Characteristics9	9.4
5.8 Typical Characteristics11	9.5
6 Parameter Measurement Information18	9.6
7 Detailed Description20	10 R
7.1 Overview	11 M
7.2 Functional Block Diagram20	Inf
7.3 Feature Description 21	

	7.4 Device Functional Modes	25
3	Application and Implementation	. 26
	8.1 Application Information	
	8.2 Typical Application - Edge Detector	.26
	8.3 Typical Application - Delayed Pulse Generator	30
	8.4 Power Supply Recommendations	.30
	8.5 Layout	. 31
)	Device and Documentation Support	.32
	9.1 Documentation Support	. 32
	9.2 Receiving Notification of Documentation Updates	.32
	9.3 Support Resources	. 32
	9.4 Trademarks	.32
	9.5 Electrostatic Discharge Caution	.32
	9.6 Glossary	.32
(	0 Revision History	. 32
•	1 Mechanical, Packaging, and Orderable	
	Information	. 32



# **4 Pin Configuration and Functions**



See mechanical drawings for dimensions.

Figure 4-1. PW Package 16-Pin TSSOP Top View

**Table 4-1. Pin Functions** 

PIN I/O <sup>(1)</sup>		UO(1)	DESCRIPTION
NAME	NO.	] 1/0(-)	DESCRIPTION
1₸	1	I	Channel 1 falling edge trigger input; requires 1T and 1CLR to be held high
1T	2	I	Channel 1 rising edge trigger input; requires 1T to be held low and 1CLR to be held high
1CLR	3	ı	Channel 1 asynchronous clear input, active low; also can operate as rising edge trigger input if 1T is held low and 1T is held high
1Q	4	0	Channel 1 inverted output
2Q	5	0	Channel 2 output
2C	6	G	Channel 2 external timing capacitor negative connection; provides a return path for discharge current of the external timing capacitor; internally connected to ground
2RC	7	I/O	Channel 2 external timing node connection; see <i>Application Information</i> section for detailed operation instructions
GND	8	G	Ground
2₹	9	I	Channel 2 falling edge trigger input; requires 2T and 2CLR to be held high
2T	10	I	Channel 2 rising edge trigger input; requires 2T to be held low and 2CLR to be held high
2CLR	11	ı	Channel 2 asynchronous clear input, active low; also can operate as rising edge trigger input if 2T is held low and 2T is held high
2Q	12	0	Channel 2 inverted output
1Q	13	0	Channel 1 output
1C	14	G	Channel 1 external timing capacitor negative connection; provides a return path for discharge current of the external timing capacitor; internally connected to ground
1RC	15	I/O	Channel 1 external timing node connection; see <i>Application Information</i> section for detailed operation instructions
V <sub>CC</sub>	16	Р	Postive voltage supply

(1) I = Input, O = Output, I/O = Input and output, G = Ground, P = Power



## **5 Specifications**

### 5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

			MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage range		-0.5	6.5	V
VI	Digital input voltage range <sup>(2)</sup>		-0.5	6.5	V
Vo	Digital output voltage range in the active state <sup>(2)</sup>		-0.5	V <sub>CC</sub> + 0.5	V
Vo	Digital output voltage range in the high-impedance state <sup>(2)</sup>		-0.5	6.5	V
V <sub>RC</sub>	RC pin voltage range		-0.5	V <sub>CC</sub> + 0.5	V
	Input clamp diode current, continuous	V <sub>I</sub> < -0.5V		-20	mA
IIK	Input clamp diode current, pulsed 1µs	V <sub>I</sub> < -0.5V		-200	mA
	Output clamp diode current, continuous	V <sub>O</sub> < -0.5V		-20	mA
lok	Output clamp diode current, pulsed 1µs	V <sub>O</sub> < -0.5V		-200	mA
	Digital output current, continuous	$V_O = 0$ to $V_{CC}$		±50	mA
Io	Digital output current, pulsed 1µs	$V_O = 0$ to $V_{CC}$		±200	mA
	Continuous current through V <sub>CC</sub> or GND			±200	mA
R <sub>ext</sub>	External timing resistance		1		kΩ
C <sub>ext</sub>	External timing capacitance			1 <sup>(3)</sup>	μF
TJ	Junction temperature			150	°C
T <sub>stg</sub>	Storage temperature		-65	150	°C

<sup>(1)</sup> Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute maximum ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions. If briefly operating outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not sustain damage, but it may not be fully functional. Operating the device in this manner may affect device reliability, functionality, performance, and shorten the device lifetime.

- (2) The voltage ratings may be exceeded if the associated clamp current ratings are observed.
- (3) The timing capacitance maximum value may be exceeded if an external diode is added. See *Application and Implementation* section for details.

## 5.2 ESD Ratings

			VALUE	UNIT
	Electrostatic	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>	±2000	\/
V <sub>(ESD)</sub>	l	Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 <sup>(2)</sup>	±1000	V

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

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## **5.3 Recommended Operating Conditions**

over operating free-air temperature range (unless otherwise noted)

Spec	Description	Condition	MIN	MAX	UNIT
V <sub>CC</sub>	Supply voltage		1.5	5.5	V
V <sub>I</sub> <sup>(1)</sup>	Input Voltage	0	5.5	V	
Vo	Output Voltage		0	V <sub>CC</sub>	V
		V <sub>CC</sub> = 1.5V		-4	mA
		V <sub>CC</sub> = 1.8V		-6	mA
I <sub>OH</sub> <sup>(2)</sup>	High-level output current	V <sub>CC</sub> = 2.5V		-26	mA
		V <sub>CC</sub> = 3.3V		-50	mA
		V <sub>CC</sub> = 5V		-50	mA
		V <sub>CC</sub> = 1.5V		4	mA
	Low-level output current	V <sub>CC</sub> = 1.8V		6	mA
I <sub>OL</sub> (2)		V <sub>CC</sub> = 2.5V		26	mA
I <sub>OL</sub> <sup>(2)</sup>		V <sub>CC</sub> = 3.3V		50	mA
		V <sub>CC</sub> = 5V		50	mA
R <sub>ext</sub> (3)	External timing resistance	V <sub>CC</sub> = 1.5V to 5.5V	6.5	1000	kΩ
C <sub>ext</sub> (3)	External timing capacitance	V <sub>CC</sub> = 1.5V to 5.5V	0.1	1000	nF
t <sub>wo</sub>	Configured output pulse width	V <sub>CC</sub> = 1.5V to 5.5V	0.01	880	S
C <sub>L</sub>	Digital output load capacitance	V <sub>CC</sub> = 1.5V to 5.5V		50	pF
V <sub>POR</sub>	Power-on reset ramp voltage	Δt/ΔV <sub>CC</sub> ≥ 20μs/V	0.3	1.5	V
Δt/ΔV <sub>CC</sub>	Power-on ramp rate	V <sub>CC</sub> = 0.3V to 1.5V	20		μs/V
Δt/Δν	Input transition rise or fall rate	V <sub>CC</sub> = 1.5V to 5.5V		100	ms/V
T <sub>A</sub>	Operating free-air temperature	Operating free-air temperature	-40	125	°C

<sup>(1)</sup> All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation.

#### **5.4 Thermal Information**

PACKAGE	PINS			THERMAL	METRIC <sup>(1)</sup>			UNIT
PACKAGE	FINS	R <sub>0JA</sub>	R <sub>0JC(top)</sub>	R <sub>0JB</sub>	$\Psi_{JT}$	$\Psi_{JB}$	R <sub>0JC(bot)</sub>	UNII
PW (TSSOP)	16	138.3	75.1	96.5	19.4	95.5	N/A	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application note.

<sup>(2)</sup> Recommended maximum output current for continuous operation; see *Electrical Characteristics* for test current values to maintain V<sub>OH</sub> and V<sub>OL</sub> specifications. Operating with average output current greater than 12mA may impact device reliability and shorten the device lifetime.

<sup>(3)</sup> Recommended R<sub>ext</sub> and C<sub>ext</sub> values maintain maximum error provided as Δt<sub>wo</sub> in the Switching Characteristics table.



### **5.5 Electrical Characteristics**

Over operating free-air temperature range; typical values measured at  $T_A$  = 25°C (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	V <sub>cc</sub>	MIN	TYP	MAX	UNIT
			1.5V	0.65	0.84	0.96	
			1.8V	0.73	0.95	1.11	
.,	Positive		2.5V	0.88	1.11	1.33	V
$V_{T+}$	switching threshold		3.3V	1.03	1.27	1.5	V
			5V	1.33	1.58	1.82	
			5.5V	1.41	1.67	1.91	
			1.5V	0.32	0.41	0.5	
			1.8V	0.36	0.46	0.53	
\	Negative		2.5V	0.45	0.55	0.63	V
V <sub>T-</sub>	switching threshold		3.3V	0.54	0.65	0.74	V
			5V	0.7	0.85	0.96	
			5.5V	0.74	0.89	1.02	
			1.5V	0.33	0.45	0.6	
			1.8V	0.36	0.5	0.65	
A \ /	Hysteresis		2.5V	0.42	0.56	0.72	.,
$\Delta V_T$	(V <sub>T+</sub> - V <sub>T-</sub> )		3.3V	0.49	0.62	0.78	V
			5V	0.61	0.74	0.91	
			5.5V	0.65	0.77	0.95	
		I <sub>OH</sub> = -50μA	1.5V - 5.5V	V <sub>CC</sub> - 0.1	V <sub>CC</sub> - 0.01		
	High-level output voltage	I <sub>OH</sub> = -1mA	1.65V	1.2	1.61		V
.,		I <sub>OH</sub> = -2mA	2.3V	2.1	2.24		
V <sub>OH</sub>		I <sub>OH</sub> = -8mA	3V	2.4	2.78		
		I <sub>OH</sub> = -12mA	4.5V	3.94	4.21		
		I <sub>OH</sub> = -12mA	5.5V	4.94	5.23		V
		I <sub>OL</sub> = 50μA	1.5V - 5.5V		0.01	0.1	
		I <sub>OL</sub> = 1mA	1.65V		0.03	0.45	
.,	Low-level	I <sub>OL</sub> = 2mA	2.3V		0.04	0.2	.,
V <sub>OL</sub>	output voltage	I <sub>OL</sub> = 8mA	3V		0.13	0.4	V
		I <sub>OL</sub> = 12mA	4.5V		0.15	0.5	
		I <sub>OL</sub> = 12mA	5.5V		0.13	0.5	
II	Input leakage current	V <sub>I</sub> = 5.5V or 0V	0V to 5.5V			±50	nA
I <sub>CEXT</sub>	Capacitor pin current	Monitor state, V <sub>CEXT</sub> = 0.5 × V <sub>CC</sub>	1.5V to 5.5V			±50	nA
		Active state, discharging, V <sub>CEXT</sub> = 1.5V	1.5V			11	mA
		Active state, discharging, V <sub>CEXT</sub> = 2.3V	2.3V			29	mA
I <sub>CEXT</sub>	Capacitor pin current	Active state, discharging, V <sub>CEXT</sub> = 3V	3V			45	mA
		Active state, discharging, V <sub>CEXT</sub> = 4.5V	4.5V			95	mA
		Active state, discharging, V <sub>CEXT</sub> = 5.5V	5.5V			138	mA
I <sub>off</sub>	Partial power- off current	V <sub>I</sub> or V <sub>O</sub> = 5.5V or 0V	0V to 0.3V		0.25	10	μA
I <sub>CC</sub>	Supply current	Ready state, V <sub>I</sub> = V <sub>CC</sub> or 0V, I <sub>O</sub> = 0	5.5V		0.19	2	μA

Over operating free-air temperature range; typical values measured at  $T_A = 25$ °C (unless otherwise noted)

PA	RAMETER	TEST CONDITIONS	V <sub>cc</sub>	MIN	TYP	MAX	UNIT
			1.5V			180	
			1.65V			200	
l	Supply current	Active state per channel, $V_1 = V_{CC}$ or 0V, $I_0 = 0$	2.3V			290	μA
I <sub>CC</sub>	Supply current	Active state per channel, $V_1 = V_{CC}$ or $V_1 = 0$	3V			450	μΑ
			4.5V			836	
			5.5V			1126	
ΔI <sub>CC</sub>	Supply-current change	One input, $V_i$ = 0 to $V_{CC}$ , all other inputs at $V_{CC}$ or 0V, $I_O$ = 0mA	1.5V to 5.5V			2.1	mA
C <sub>I</sub>	Input capacitance	V <sub>I</sub> = 5.5V or 0V	5.5V		1		pF
Co	Output capacitance	V <sub>O</sub> = 5.5V or 0V	0V		3		pF
			1.5V	16	17.9	20	
			1.65V	14	15.5	17	pF
_	Internal	$C_{\text{ext}} = 0 \text{pF}; V_{\text{cext}} = 0 \text{ to } V_{\text{CC}}$	2.3V	7	9.7	13	
C <sub>int</sub>	capacitance	Cext - Opi , v cext - O to v CC	3V	6	9.9	14	
			4.5V	5	7.7	10	
			5.5V	4	5.7	7	

# **5.6 Timing Characteristics**

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	DESCRIPTION	CONDITION	V <sub>CC</sub>	MIN	MAX	UNIT
			1.5V	18.2		
			1.8V ± 0.15V	9.9		
t <sub>wi</sub>	Pulse duration	Any trigger input	2.5V ± 0.2V	7.8		ns
			3.3V ± 0.3V	5.8		
			5V ± 0.5V	4.1		
			1.5V	9.6		
			1.8V ± 0.15V	8		
		$\overline{T}$ low before $T\uparrow$ or $\overline{CLR}\uparrow$ $T \text{ high before } \overline{T}\downarrow \text{ or } \overline{CLR}\uparrow$	2.5V ± 0.2V	6.9		ns
			3.3V ± 0.3V	6.6		
			5V ± 0.5V	6.5		
			1.5V	5		
			1.8V ± 0.15V	5		
t <sub>su</sub>	Setup time between trigger inputs		2.5V ± 0.2V	5		ns
	ingger inpute		3.3V ± 0.3V	5		
			5V ± 0.5V	5		
			1.5V	9.2		
			1.8V ± 0.15V	7.8		
		CLR high before T↓ or T↑	2.5V ± 0.2V	6.7		ns
			3.3V ± 0.3V	6.5		
			5V ± 0.5V	6.4		



over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	DESCRIPTION	CONDITION	V <sub>cc</sub>	MIN	MAX	UNIT
			1.5V	9.3		
			1.8V ± 0.15V	7.8		
t <sub>h</sub>	Hold time	Any trigger input	2.5V ± 0.2V	6.7		ns
			3.3V ± 0.3V	6.5		
			5V ± 0.5V	6.4		
			1.5V	13.1		
			1.8V ± 0.15V	13		
		Any trigger input, $R_{ext}$ = 100k $\Omega$ , $C_{ext}$ = 100pF	2.5V ± 0.2V	12.6		μs
			3.3V ± 0.3V	12.5		
			5V ± 0.5V	12.2		
			1.5V	2		
			1.8V ± 0.15V	2		ms
t <sub>rr</sub> <sup>(1)</sup>	Retrigger time		2.5V ± 0.2V	2		
			3.3V ± 0.3V	2.1		
			5V ± 0.5V	2.1		
			1.5V	912		
			1.8V ± 0.15V	911		
		Any trigger input, $R_{ext} = 10k\Omega$ , $C_{ext} = 10\mu F$	2.5V ± 0.2V	904		ms
			3.3V ± 0.3V	893		
			5V ± 0.5V	864		
t <sub>startup</sub> (2)	Startup time		1.5V to 5.5V		0	μs

- (1) Triggering the clear input (CLR) more often than 2500 × C<sub>ext</sub> may affect long-term reliability of the device. Repeated fast triggering of the clear input causes excessive average current at the RC pin.
- (2) Triggers received during device startup may be ignored. The external timing capacitor requires time to charge after startup. For optimal first pulse accuracy, wait a minimum of 500 × C<sub>ext</sub> after supply voltage has reached stable operating conditions before applying the first trigger.

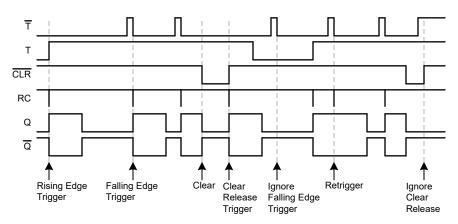


Figure 5-1. Input/Output Timing Diagram

## **5.7 Switching Characteristics**

over operating free-air temperature range; typical values measured at  $T_A$  = 25°C (unless otherwise noted). See *Parameter Measurement Information*.

PARAME TER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V <sub>cc</sub>	MIN	TYP	MAX	UNIT
C <sub>L</sub> = 15pF						,		
				1.5V	7	35	59	
				1.65V	6	28.6	47	
	T T CID	0 0	0 - 45-5	2.3V	4	16.6	26	
t <sub>pd</sub>	T, T, or CLR	Q or Q	C <sub>L</sub> = 15pF	3V	3	12.4	19	ns
				4.5V	2	9.4	13	
				5.5V	2	9.2	12	
				1.5V		4.3	8.3	
				1.65V		3.9	7	
		O or $\overline{\square}$	C = 15pF	2.3V		3	5.6	
t <sub>t</sub>		Q or Q	C <sub>L</sub> = 15pF	3V		2.5	5	ns
				4.5V		2.4	4.9	
				5.5V		2.7	5.8	
C <sub>L</sub> = 50pF				1			l	
				1.5V	7	37	67	
	T, T, or CLR Q or Q		1.65V	6	30.2	53	1	
		Q or Q	C <sub>L</sub> = 50pF	2.3V	4	17.6	30	ns
t <sub>pd</sub>				3V	3	13	22	
				4.5V	2	9.8	16	
				5.5V	2	9.6	14	
			$R_{\text{ext}} = 1M\Omega; C_{\text{ext}} = 0;$ $C_{\text{L}} = 50 \text{pF}$	1.5V	2.3	3.6	4.4	ms
				1.65V	2.5	3.5	4.3	
				2.3V	2.2	3.4	4.1	
				3V	2.2	3.3	4	
				4.5V	2.1	3.2	3.8	
				5.5V	2	3.1	3.8	
				1.5V	831	934	1017	
				1.65V	832	934	1018	
. (4)			$R_{\text{ext}} = 10 \text{k}\Omega; C_{\text{ext}} =$	2.3V	837	932	1024	
t <sub>wo</sub> (1)		Q or Q	0.1µF; C <sub>L</sub> = 50pF	3V	842	938	1030	ms
				4.5V	852	949	1043	
				5.5V	857	954	1049	
				1.5V	261	295	324	
				1.65V	250	301	316	
			Royt = 330kO: Cout =	2.3V	253	298	315	
			$R_{\text{ext}} = 330 \text{k}\Omega; C_{\text{ext}} = 1 \mu \text{F}; C_{\text{L}} = 50 \text{pF}$	3V	255	300	317	S
				4.5V	261	306	320	
				5.5V	264	310	323	-
Δt <sub>wo</sub> <sup>(2)</sup>		Q or Q	C <sub>L</sub> = 50pF	1.5V to 5.5V		±1	±10	%



over operating free-air temperature range; typical values measured at T<sub>A</sub> = 25°C (unless otherwise noted). See *Parameter* Measurement Information.

PARAME TER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	V <sub>cc</sub>	MIN TYP	MAX	UNIT
				1.5V	8.2	34.4	
				1.65V	7	28	
		0 0	0 - 50-5	2.3V	4.5	24.6	ns
t <sub>t</sub>		Q or Q		3V	3.9	17.4	
				4.5V	3.1	12.6	
				5.5V	2.9	8.7	
			$T = V_{CC}$ , $\overline{T} = GND f_I$ = 10MHz $C_L = 50pF$	1.5V	46		
				1.65V	46		
Q (3)	OL D			2.3V	49		
C <sub>pd</sub> (3)	CLR		C <sub>ext</sub> = 0pF R <sub>ext</sub> =	3V	40		pF
			1ΜΩ	4.5V	47		
				5.5V	49		

<sup>(1)</sup> Output pulse width

Variation in output pulse width as compared to typical characteristics for K factor excluding variations in external timing components. Power dissipation capacitance is calculated in accordance with CMOS Power Consumption and Cpd Calculation. (2)

## **5.8 Typical Characteristics**

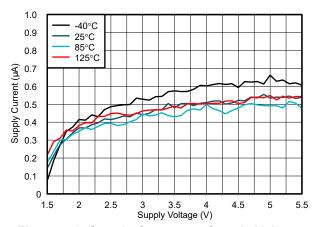
T<sub>A</sub> = 25°C (unless otherwise noted)

Table 5-1. Pulse width using common RC,  $V_{CC} = 3.3V$ 

Resistor Value	Capacitor Value										
	10μF	1µF	100nF	10nF	1nF	100pF	10pF				
1kΩ	10.1s	1.01s	106ms	11.0ms	1.21ms <sup>(1)</sup>	179µs <sup>(1)</sup>	61.9µs <sup>(1)</sup>				
1.5kΩ	15.0s	1.50s	1.53ms	15.9ms	1.74ms <sup>(1)</sup>	242µs <sup>(1)</sup>	69.4µs <sup>(1)</sup>				
2.2kΩ	21.7s	2.17s	220ms	22.7ms	2.49ms <sup>(1)</sup>	331µs <sup>(1)</sup>	84.7µs <sup>(1)</sup>				
3.3kΩ	32.1s	3.21s	326ms	33.5ms	3.64ms <sup>(1)</sup>	468µs <sup>(1)</sup>	102µs <sup>(1)</sup>				
4.7kΩ	45.3s	4.53s	460ms	47.2ms	5.14ms <sup>(1)</sup>	643µs <sup>(1)</sup>	125µs <sup>(1)</sup>				
6.8kΩ	65.2s	6.52s	661ms	68.1ms	7.36ms <sup>(1)</sup>	904µs <sup>(1)</sup>	157µs <sup>(1)</sup>				
10kΩ	95.1s	9.51s	966ms	99.5ms	10.8ms	1.30ms <sup>(1)</sup>	207µs <sup>(1)</sup>				
15kΩ	143s	14.3s	1.44s	149ms	16.1ms	1.92ms <sup>(1)</sup>	281µs <sup>(1)</sup>				
22kΩ	209s	20.9s	2.12s	218ms	23.4ms	2.79ms <sup>(1)</sup>	387µs <sup>(1)</sup>				
33kΩ	313s	31.3s	3.16s	327ms	35.3ms	4.14ms <sup>(1)</sup>	552µs <sup>(1)</sup>				
47kΩ	444s	44.4s	4.50s	464ms	49.8ms	5.88ms <sup>(1)</sup>	763µs <sup>(1)</sup>				
68kΩ	644s	64.4s	6.52s	670ms	72.3ms	8.47ms <sup>(1)</sup>	1.06ms <sup>(1)</sup>				
100kΩ	946s	94.6s	9.58s	985ms	106ms	12.5ms	1.55ms <sup>(1)</sup>				
150kΩ	1420s	142s	14.3s	1.48s	160ms	18.5ms	2.29ms <sup>(1)</sup>				
220kΩ	2080s	208s	21.0s	2.17s	234ms	27.3ms	3.32ms <sup>(1)</sup>				
330kΩ	2924s <sup>(2)</sup>	312s	31.5s	3.25s	351ms	40.6ms	4.94ms <sup>(1)</sup>				
470kΩ	2939s <sup>(2)</sup>	444s	44.9s	4.64s	501ms	58.0ms	7.02ms <sup>(1)</sup>				
680kΩ	2962s <sup>(2)</sup>	643s	64.9s	6.69s	724ms	84.3ms	10.1ms				
1ΜΩ	2995s <sup>(2)</sup>	940s	95.8s	9.88s	1.06s	125ms	14.8ms				

<sup>(1)</sup> Pulse widths configured for less than 10ms (K×R×C < 10 $\mu$ s) can fail to properly trigger the state machine resulting in very short output pulses ( $t_{wo}$  < 10 $\mu$ s).

<sup>(2)</sup> Pulse widths configured for more than 2253s (K×R×C > 2.2s) can vary significantly due to exceeding the digital timing circuitry capabilities.





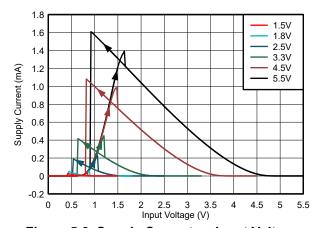
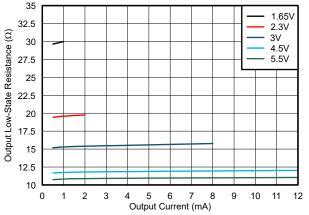


Figure 5-3. Supply Current vs Input Voltage





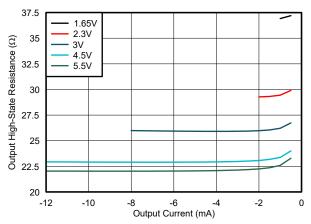
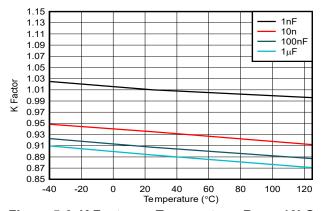


Figure 5-4. Output Low-State Resistance vs Output Current

Figure 5-5. Output High-State Resistance vs Output Current



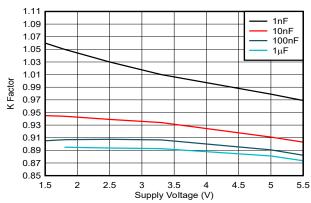


Figure 5-6. K Factor vs Temperature,  $R_{ext} = 10k\Omega$ 

Figure 5-7. K Factor vs Supply Voltage,  $R_{ext} = 10k\Omega$ 

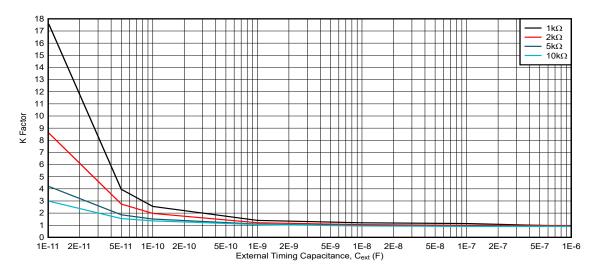


Figure 5-8. K Factor,  $V_{CC}$  = 1.5V,  $R_{ext}$  = 1k $\Omega$  to 10k $\Omega$ 

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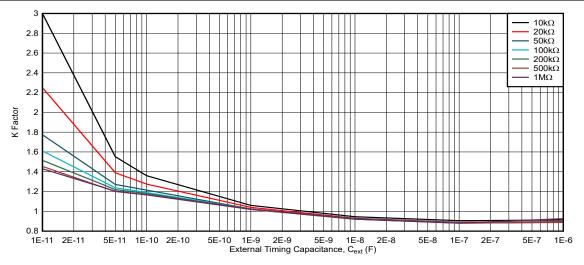


Figure 5-9. K Factor,  $V_{CC}$  = 1.5V,  $R_{ext}$  = 10k $\Omega$  to 1M $\Omega$ 

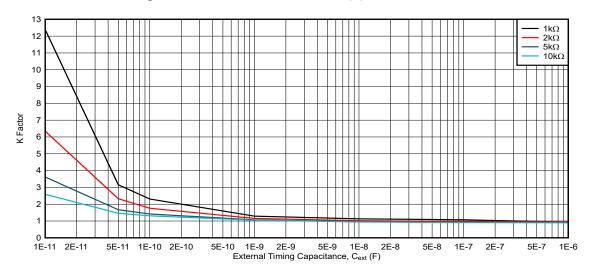


Figure 5-10. K Factor,  $V_{CC}$  = 1.8V,  $R_{ext}$  = 1k $\Omega$  to 10k $\Omega$ 

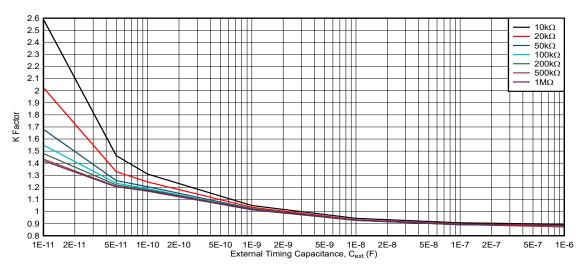


Figure 5-11. K Factor,  $V_{CC}$  = 1.8V,  $R_{ext}$  = 10k $\Omega$  to 1M $\Omega$ 



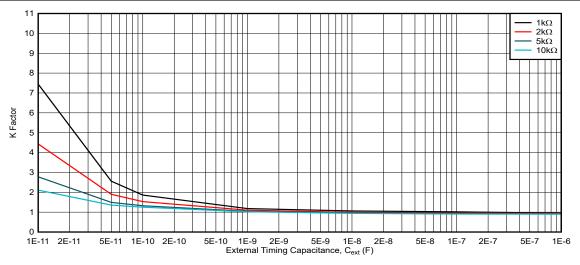


Figure 5-12. K Factor,  $V_{CC}$  = 2.5V,  $R_{ext}$  = 1k $\Omega$  to 10k $\Omega$ 

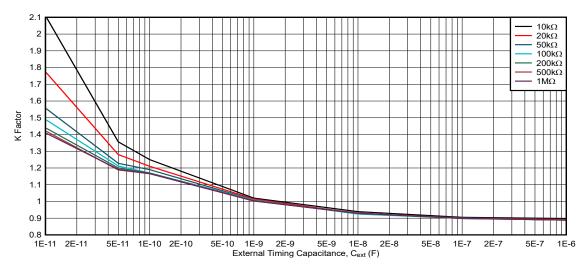


Figure 5-13. K Factor,  $V_{CC}$  = 2.5V,  $R_{ext}$  = 10k $\Omega$  to 1M $\Omega$ 

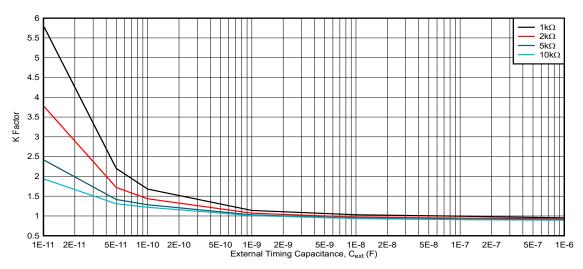


Figure 5-14. K Factor,  $V_{CC}$  = 3.3V,  $R_{ext}$  = 1k $\Omega$  to 10k $\Omega$ 

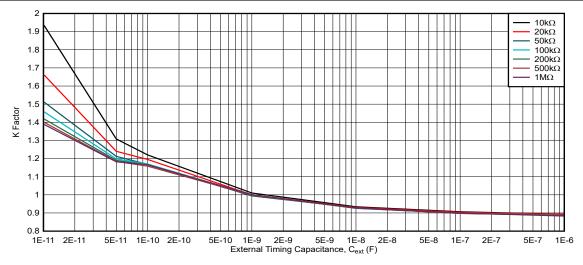


Figure 5-15. K Factor,  $V_{CC}$  = 3.3V,  $R_{ext}$  = 10k $\Omega$  to 1M $\Omega$ 

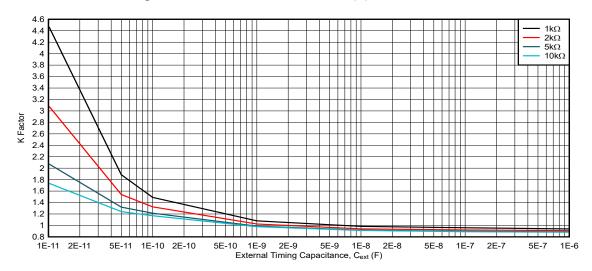


Figure 5-16. K Factor,  $V_{CC}$  = 5V,  $R_{ext}$  = 1k $\Omega$  to 10k $\Omega$ 

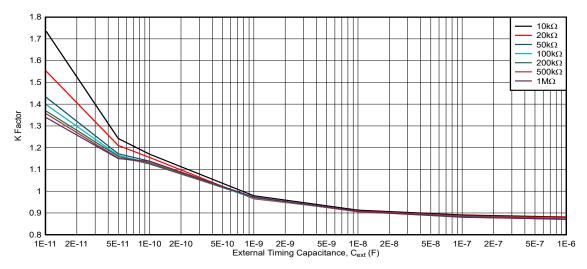


Figure 5-17. K Factor,  $V_{CC}$  = 5V,  $R_{ext}$  =  $10k\Omega$  to  $1M\Omega$ 



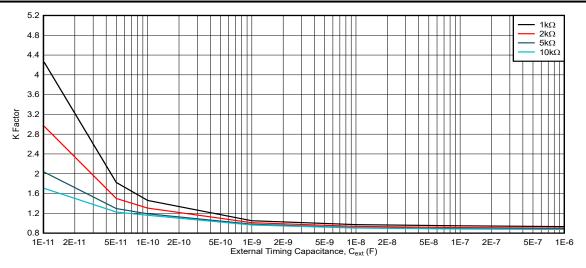


Figure 5-18. K Factor,  $V_{CC}$  = 5.5V,  $R_{ext}$  = 1k $\Omega$  to 10k $\Omega$ 

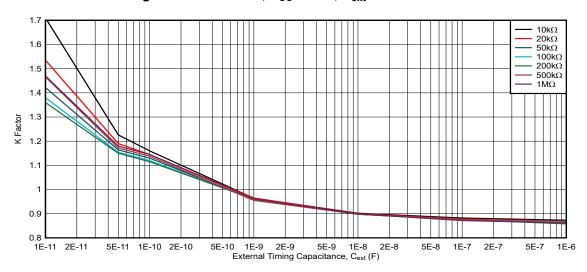


Figure 5-19. K Factor,  $V_{CC}$  = 5.5V,  $R_{ext}$  = 10k $\Omega$  to 1M $\Omega$ 

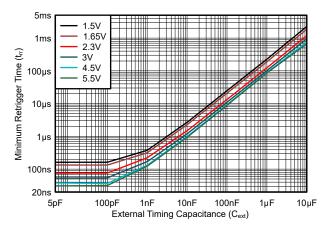


Figure 5-20. Minimum retrigger time versus external timing capacitor value

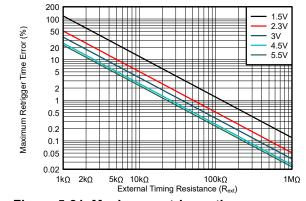


Figure 5-21. Maximum retrigger time error as a percentage of total pulse width versus external timing resistor value

Error data in the following plots indicates changes from typical behavior (nominal material,  $T_A = 25$ °C) due to variation in manufacturing process and operating free-air temperature.

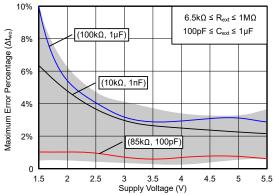


Figure 5-22. Maximum output pulse width error (absolute value) across supply voltage Each line: one timing component combination Shaded area: all timing component combinations

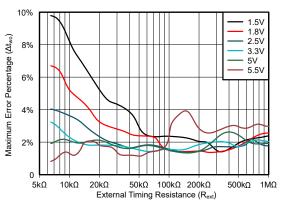


Figure 5-23. Maximum output pulse width error (absolute value) versus timing resistor values with  $C_{\text{ext}} = 100 \text{pF}$ 

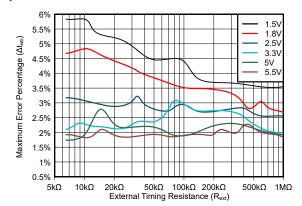


Figure 5-24. Maximum output pulse width error (absolute value) versus timing resistor values with C<sub>ext</sub> = 1nF



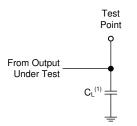
 $V_{CC}$ 

50%

### **6 Parameter Measurement Information**

Phase relationships between waveforms were chosen arbitrarily for the examples listed in the following table. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1MHz,  $Z_O = 50\Omega$ ,  $t_t < 2.5$ ns.

The outputs are measured individually with one input transition per measurement.





50%

Input

(1) C<sub>1</sub> includes probe and test-fixture capacitance.

Figure 6-1. Load Circuit for Push-Pull Outputs

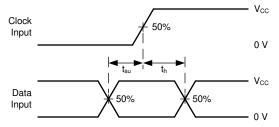
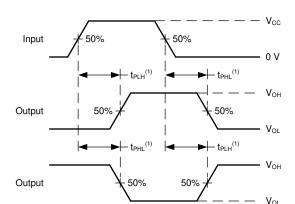


Figure 6-3. Voltage Waveforms, Setup and Hold Times



(1) The greater between  $t_{PLH}$  and  $t_{PHL}$  is the same as  $t_{pd}$ .

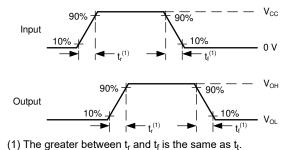


Figure 6-5. Voltage Waveforms, Input and Output
Transition Times

Figure 6-4. Voltage Waveforms Propagation Delays

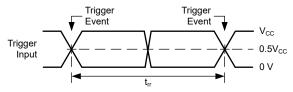


Figure 6-6. Voltage Waveforms, Retrigger Time

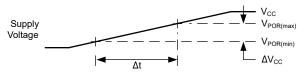


Figure 6-7. Voltage Waveforms, Supply Ramp

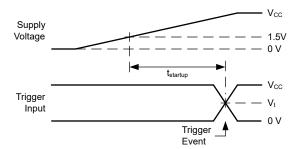


Figure 6-8. Voltage Waveforms, Startup Time



## 7 Detailed Description

### 7.1 Overview

The TPUL2T323 device contains two independent extended-pulse-width retriggerable monostable multivibrator circuits. A monostable multivibrator, also commonly known as a "one shot," produces a single digital pulse when triggered and otherwise maintains a constant output state.

The TPUL2T323 device features three gated trigger inputs for each channel. For a rising edge trigger, the T or  $\overline{\text{CLR}}$  input is used. For a falling edge trigger the  $\overline{\text{T}}$  input is used.

The TPUL2T323 device includes an asynchronous clear input (CLR) that can be used to terminate an ongoing output pulse.

When triggered, the TPUL2T323 outputs a positive digital pulse with pulse width defined as  $t_{wo}$  = 1024 × K ×  $R_{ext}$  ×  $C_{ext}$ , with  $R_{ext}$  and  $C_{ext}$  being the external timing resistor and external timing capacitor component values measured in  $\Omega$  and F, respectively, and K being a unitless nonlinearity correction factor provided in the *Typical Characteristics* section. The external timing components must be connected as shown in Figure 7-1. The external ground connection to the C terminal is optional.

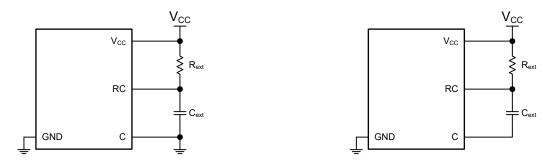


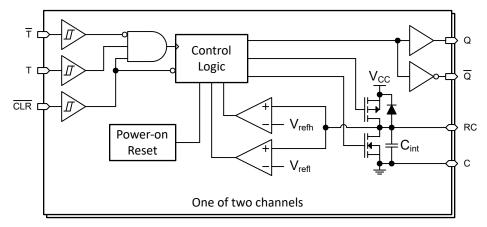
Figure 7-1. Timing component connection, with and without external ground

#### 7.2 Functional Block Diagram

 $V_{refh} = 0.69 \times V_{CC}$ 

 $V_{refl} = 0.25 \times V_{CC}$ 

C<sub>int</sub> indicates total internal parasitic capacitance and can be found in the *Electrical Characteristics* table.



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## 7.3 Feature Description

#### 7.3.1 Naming Convention

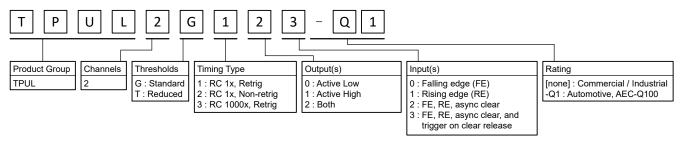


Figure 7-2. Device name meaning

### 7.3.2 Retriggerable One-Shot

This device includes a retriggerable monostable multivibrator (one-shot) circuit that produces a fixed-width output pulse. The output pulse width for a retriggerable one-shot is extended by additional input triggers while the output is active. The output pulse will expire after the configured time period if no other triggers have been received.

The output pulse width after a retrigger event is always shorter than the normal output pulse width because the timing capacitor does not need to be fully discharged for a retrigger event. The maximum error due to this change is the time to discharge the selected timing capacitor. The error due to retrigger timing can be minimized by selecting larger resistor values and smaller capacitor values for a given pulse width. See retrigger plots in the *Typical Characteristics* section for more details.

#### 7.3.3 Extended RC Timed One-Shot

The output pulse width ( $t_{wo}$ ) is controlled by the selection of external timing components  $R_{ext}$  and  $C_{ext}$ . The TPUL2T323 has been designed to target a typical output pulse width of  $t_{wo} \cong 1000 \times R_{ext} \times C_{ext}$ , however the actual pulse width changes with multiple variables, and thus a nonlinearity correction factor, K, is added to provide the system designer with a more accurate pulse width estimation. Equation 1 is used to most accurately predict the output pulse width.

$$t_{wo} = K \times 1024 \times R_{ext} \times C_{ext} \tag{1}$$

The output pulse width is dependent on multiple variables:

- External timing components (R<sub>ext</sub>, C<sub>ext</sub>)
- Voltage
- Temperature
- · Manufacturing and design
- Digital state machine operation

The external timing component values directly control the output pulse width, and any variations in component values due to manufacturing, voltage, or temperature will directly impact the output pulse width.

Most resistors maintain very consistent values during operation, and thus tend to have little impact on accuracy.

Most capacitors have a wide variation of manufacturing values, and additionally can vary due to temperature and operating voltage. Typically, the timing capacitor is the largest single source of error for RC timed monostable multivibrators.

There is also some error introduced by the TPUL2T323. This error is provided as  $\Delta t_{wo}$  in the *Switching Characteristics* section and includes variations due to digital state machine operation, design, manufacturing, and temperature. There is additionally some randomness inherent to the pulse width even with all other factors held constant which is typically less than 1% and is accounted for in the  $\Delta t_{wo}$  specification.

Estimating the percent error of the output pulse width ( $e_{\Delta two}$ ) requires multiple inputs. Equation 2 provides the best method to estimate total pulse width error due to tolerance of components, with  $e_R$  being the error introduced by the timing resistor,  $e_C$  being the error introduced by the timing capacitor, and  $\Delta t_{wo}$  being the error introduced by the TPUL2T323.

$$e_{\Delta two} = e_R + e_C + e_R e_C + \Delta t_{wo} (1 + e_R + e_C + e_R e_C)$$
(2)

For a quick estimate, the sum of the error values can be used ( $e_{\Delta two} \cong e_R + e_C + \Delta t_{wo}$ ). For example, a typical TPUL2T323 application circuit using an X7R capacitor (5% manufacturing tolerance + 15% temperature variation), 0.1% resistor, and  $\Delta t_{wo}$  of 5% would have a quickly estimated maximum error of 25.1%. With the more accurate equation, the maximum error is actually 26.126%.

### 7.3.4 Balanced CMOS Push-Pull Outputs

This device includes balanced CMOS push-pull outputs. The term *balanced* indicates that the device can sink and source similar currents. The drive capability of this device may create fast edges into light loads, so routing and load conditions should be considered to prevent ringing. Additionally, the outputs of this device are capable of driving larger currents than the device can sustain without being damaged. It is important to limit the output power of the device to avoid damage due to overcurrent. The electrical and thermal limits defined in the *Absolute Maximum Ratings* must be followed at all times.

Unused push-pull CMOS outputs must be left disconnected.

#### 7.3.5 CMOS Schmitt-Trigger Inputs

This device includes inputs with the Schmitt-trigger architecture. These inputs are high impedance and are typically modeled as a resistor in parallel with the input capacitance given in the *Electrical Characteristics* table from the input to ground. The worst case resistance is calculated with the maximum input voltage, given in the *Absolute Maximum Ratings* table, and the maximum input leakage current, given in the *Electrical Characteristics* table, using Ohm's law  $(R = V \div I)$ .

The Schmitt-trigger input architecture provides hysteresis as defined by  $\Delta V_T$  in the *Electrical Characteristics* table, which makes this device extremely tolerant to slow or noisy inputs. While the inputs can be driven much slower than standard CMOS inputs, it is still recommended to properly terminate unused inputs. Driving the inputs with slow transitioning signals will increase dynamic current consumption of the device with the maximum value per input defined as  $\Delta I_{CC}$  in the *Electrical Characteristics* table. For additional information regarding Schmitt-trigger inputs, please see *Understanding Schmitt Triggers*.

Do not leave inputs floating at any time during operation. Unused inputs must be terminated at a valid high or low voltage level. If a system is not actively driving an input at all times, then a pull-up or pull-down resistor can be added to provide a valid input voltage during these times. The resistor value will depend on multiple factors; however, a  $10k\Omega$  resistor is recommended and will typically meet all requirements.

#### 7.3.6 Latching Logic with Known Power-Up State

This device includes latching logic circuitry. Latching circuits commonly include D-type latches and D-type flip-flops, but include all logic circuits that act as volatile memory. In typical logic devices, the output state of each latching circuit is unknown after power is initially applied; however, this device includes an added Power On Reset (POR) circuit which sets the states of all included latching circuits during the power-up ramp prior to the device starting normal functionality.

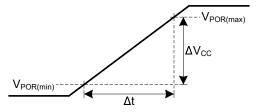


Figure 7-3. Supply (V<sub>CC</sub>) Ramp Characteristics for Known Power-Up State

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Figure 7-3 shows a correct supply voltage turn-on ramp and defines values used in the *Recommended Operating Conditions* and *Electrical Characteristics* tables.

Prior to starting the power-on ramp, the supply must be completely off  $(V_{CC} \le V_{POR(min)})$ .

The supply voltage must ramp at a rate within the range provided in the *Recommended Operating Conditions* table.

The output state of each latching logic circuit only remains stable as long as power is applied to the device ( $V_{CC} \ge V_{POR(max)}$ ).

Variation from these recommendations will result in the device having an unknown power-up state.

### 7.3.7 Partial Power Down (Ioff)

This device includes circuitry to disable all outputs when the supply pin is held at 0V. When disabled, the outputs will neither source nor sink current, regardless of the input voltages applied. The amount of leakage current at each output is defined by the I<sub>off</sub> specification in the *Electrical Characteristics* table.

### 7.3.8 Reduced Input Threshold Voltages

The TPUL2T323 was designed with reduced input voltage thresholds to support up-translation and inputs tolerant to 5.5V signal levels to support down-translation. For proper functionality, input signals must remain at or above the specified  $V_{T+(MAX)}$  ( $V_{IH}$ ) level for a HIGH input state, and at or below the specified  $V_{T-(MIN)}$  ( $V_{IL}$ ) for a LOW input state. Figure 7-4 shows the typical  $V_{IH}$  and  $V_{IL}$  levels for TPULxT devices, as well as the voltage levels for standard CMOS devices for comparison.

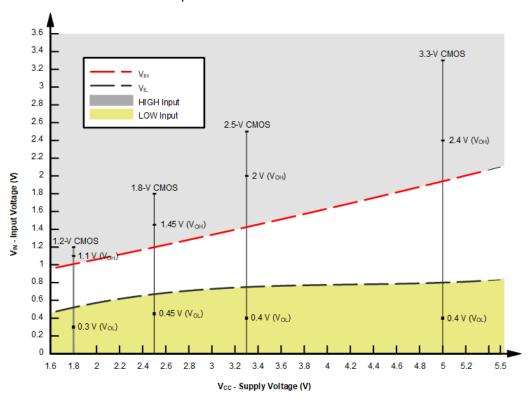


Figure 7-4. TPULxT Input Voltage Levels



### 7.3.9 Clamp Diode Structure

Figure 7-5 shows the inputs and outputs to this device have negative clamping diodes only.

### **CAUTION**

Voltages beyond the values specified in the *Absolute Maximum Ratings* table can cause damage to the device. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

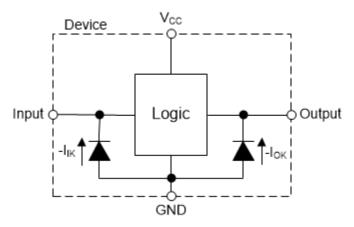


Figure 7-5. Electrical Placement of Clamping Diodes for Each Input and Output

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#### 7.4 Device Functional Modes

#### 7.4.1 Off-State Operation

The TPUL2T323 includes partial-power-down (I<sub>off</sub>) protection, which forces the outputs into a high-impedance state when the supply voltage is approximately 0V. In the powered-off state, voltages can be applied to the digital inputs and outputs and the device will not respond or have any back-powering. This protection does not apply to the RC pin.

### 7.4.2 Startup Operation

The TPUL2T323 includes an internal power-on reset (POR) circuit that prevents erroneous triggers from occurring during startup. There are details on the supply ramp requirements provided in *Latching Logic with Known Power-Up State*. Normal operation can be started after the startup time (t<sub>startup</sub>) has expired per the *Timing Requirements* table. While active, the POR circuit holds the TPUL2T323 in the *Ready* state.

### 7.4.3 On-State Operation

The table below lists the on-state functional modes for the TPUL2T323.

	Table 7-1. FullCuon Table										
	INPUTS <sup>(1)</sup>		OUTPUTS <sup>(2)</sup>								
CLR	Ŧ	Т	Q	Q							
L	Х	Х	L	Н							
Н	Н	Х	L(3)	H <sup>(3)</sup>							
Н	Х	L	L(3)	H <sup>(3)</sup>							
Н	L	1	(4)	(4)							
Н	<b>1</b>	Н	(4)	(4)							
1	L	Н	JL								

**Table 7-1. Function Table** 

- (1) H = high voltage level, L = low voltage level, X = don't care
- (2) L = driving low, H = driving high, \( \subseteq \subseteq \) = driving high for the defined pulse width time, \( \subseteq \subseteq \subseteq \subseteq \) are driving low for the defined pulse width time
- (3) These outputs are based on the assumption that the indicated steady-state conditions at the inputs have been set up long enough to complete any output pulse.
- (4) If an output pulse is triggered while a previous output pulse is still active, the output continues to drive high for one additional pulse width.

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## 8 Application and Implementation

#### Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

### 8.1 Application Information

The TPUL2T323 is used to generate a fixed-width pulse from an input trigger event. This device is retriggerable, meaning that input triggers received while the output is active will cause the output pulse to extend and it will not expire until one configured time period after the most recent trigger.

The input trigger event comes from three gated inputs:  $\overline{T}$ , T, and  $\overline{CLR}$ . These inputs are combined in a 3-input AND gate, with  $\overline{T}$  internally inverted such that the logic follows the boolean equation  $Y = !(\overline{T}) \cdot T \cdot \overline{CLR}$ . Each input has a Schmitt-trigger architecture, and thus includes hysteresis allowing for slow transitioning or noisy signals. An input signal is detected as a logic high if the signal is larger than  $V_{T+}$ , and a low if the input signal is smaller than  $V_{T-}$ . Between  $V_{T+}$  and  $V_{T-}$ , the input signal is detected as the last valid state until one of those values is crossed. An output pulse is triggered on the rising edge of the aforementioned internal Y signal.

The output pulse width is controlled by the selection of external timing components  $R_{\text{ext}}$  and  $C_{\text{ext}}$ . Plots are provided in the *Typical Characteristics* section to easily select appropriate component values for a desired pulse width. See the *Features* section for additional information regarding the impact of external components on the timing accuracy of the TPUL2T323.

## 8.2 Typical Application - Edge Detector

In this application, the TPUL2T323 is used to detect rising or falling edges on an input signal, producing short pulses at the output for each edge detected. The circuit configuration for a rising edge detector is shown in Figure 8-1. For a falling edge detector, connect the input signal to the  $\overline{\mathsf{T}}$  input instead of the T input, and connect the T input to  $\mathsf{V}_{\mathsf{CC}}$ . Otherwise, the components and configuration are identical.

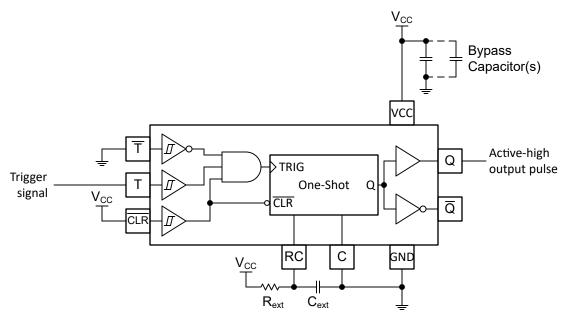


Figure 8-1. Pulse Generator Schematic Using the TPUL2T323

Product Folder Links: TPUL2T323

### 8.2.1 Design Requirements

#### 8.2.1.1 Timing Components

The external timing components directly determine the output pulse width of the TPUL2T323.

The range of supported values for  $R_{ext}$  and  $C_{ext}$  are provided in the *Recommended Operating Conditions* table. Do not exceed the limits provided in the *Absolute Maximum Ratings* table.

The TPUL2T323 can be used with no external capacitor, which is described as  $C_{ext}$  = 0pF. In this condition, the output pulse width is determined by the operating voltage and external timing resistor,  $R_{ext}$ , only. The expected variation is provided in the *Switching Characteristics* table for the case of  $R_{ext}$  = 1M $\Omega$ ,  $C_{ext}$  = 0pF.

If an external timing capacitor larger than 1µF is used, add an external Schottky diode (D<sub>ext</sub>) as shown in Figure 8-2 to provide an alternate discharge path for the capacitor during power down.

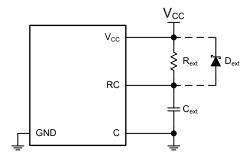


Figure 8-2. External protection diode connection

#### 8.2.1.2 Input Considerations

Input signals must cross to be considered a logic LOW, and to be considered a logic HIGH. Do not exceed the maximum input voltage range found in the *Absolute Maximum Ratings*.

Unused inputs must be terminated to either  $V_{CC}$  or ground. The unused inputs can be directly terminated if the input is completely unused, or they can be connected with a pull-up or pull-down resistor if the input will be used sometimes, but not always. A pull-up resistor is used for a default state of HIGH, and a pull-down resistor is used for a default state of LOW. The drive current of the controller, leakage current into the TPUL2T323 (as specified in the *Electrical Characteristics*), and the desired input transition rate limits the resistor size. A  $10k\Omega$  resistor value is recommended for most applications.

Refer to the *Feature Description* section for additional information regarding the inputs for this device.



#### 8.2.1.3 Output Considerations

The positive supply voltage is used to produce the output HIGH-state voltage. Drawing current from the output decreases the output voltage as specified by the  $V_{OH}$  specification in the *Electrical Characteristics*. The ground voltage is used to produce the output LOW-state voltage. Sinking current into the output increases the output voltage as specified by the  $V_{OL}$  specification in the *Electrical Characteristics*.

Push-pull outputs that could be in opposite states, even for a very short time period, should never be connected directly together to avoid excessive current and damage to the device.

The TPUL2T323 can directly drive a load with a total capacitance less than or equal to 50pF while still meeting all of the data sheet specifications. For larger capacitive loads, add a series resistor to maintain current within the *Absolute Maximum Ratings*.

The TPUL2T323 can drive a load with total resistance described by  $R_L \ge V_O / I_O$ , with the output voltage and current defined in the *Electrical Characteristics* table with  $V_{OH}$  and  $V_{OL}$ . When outputting in the HIGH state, the output voltage in the equation is defined as the difference between the measured output voltage and the supply voltage at the  $V_{CC}$  pin.

Unused outputs can be left floating. Do not connect outputs directly to V<sub>CC</sub> or ground.

Refer to the Feature Description section for additional information regarding the outputs for this device.

#### 8.2.1.4 Power Considerations

Ensure the desired supply voltage is within the range specified in the *Recommended Operating Conditions*. The supply voltage sets the electrical characteristics of the device as described in the *Electrical Characteristics* section.

The ground must be capable of sinking current equal to the total current to be sunk by all outputs of the TPUL2T323 plus the maximum supply current, I<sub>CC</sub>, listed in the *Electrical Characteristics*, and any transient current required for switching. The logic device can only sink as much current that can be sunk into its ground connection. Ensure the maximum total current through GND listed in the *Absolute Maximum Ratings* is not exceeded.

Thermal increase can be calculated using the information provided in *Thermal Characteristics of Standard Linear* and Logic (SLL) Packages and Devices.

### **CAUTION**

The maximum junction temperature,  $T_{J(max)}$  listed in the *Absolute Maximum Ratings*, is an additional limitation to prevent damage to the device. Do not violate any values listed in the *Absolute Maximum Ratings*. These limits are provided to prevent damage to the device.

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### 8.2.2 Detailed Design Procedure

Texas Instruments provides an Excel-based calculator for getting the best results when using the TPUL2T323. This calculator can be found through the device's product folder, located in the *Design and development* section. The steps below are used for manually calculating the required timing component values using the information available in this document.

- 1. Select the desired output pulse width  $(t_{wo})$ , and calculate  $t_{wo1} = t_{wo} / 1024$ .
- 2. Solve:  $C_{\text{ext1}} = t_{\text{wo1}}/50000$ .
- 3. Select the nearest decade capacitor value to  $C_{ext1}$  from the following and use for  $C_{ext}$ . { 100pF, 1nF, 10nF, 100nF, 1µF, 10µF }
- 4. Solve:  $R_{ext1} = t_{wo1}/C_{ext}$ .
- 5. Using R<sub>ext1</sub> from step 4 and C<sub>ext</sub> from step 3, find the closest K factor using the appropriate plot from the *Typical Characteristics* section.
- 6. Solve:  $R_{ext} = t_{wo1}/(K \times C_{ext})$
- 7. Connect the selected timing resistor, R<sub>ext</sub>, from RC to V<sub>CC</sub>.
- 8. Connect the selected timing capacitor, C<sub>ext</sub>, from RC (positive) to C (negative). The C pin can additionally be connected to ground, however it is not required for normal operation.
- 9. Add a 0.1µF bypass capacitor from V<sub>CC</sub> to GND. The capacitor needs to be placed physically close to the device and electrically close to both the V<sub>CC</sub> and GND pins. An example layout is shown in the *Layout* section
- 10. Ensure the capacitive load at the output is ≤ 50pF. This is not a hard limit, however, it will optimize performance and prevent reliability issues. This can be accomplished by providing short, appropriately sized traces from the TPUL2T323 to any receiving devices.
- 11. Ensure the resistive load at the output is larger than  $(V_{CC} / I_{O(max)})\Omega$ . Doing this will prevent the maximum output current from the *Absolute Maximum Ratings* from being violated. Most CMOS inputs have a resistive load measured in M $\Omega$ ; much larger than the minimum calculated previously.
- 12. Thermal issues are rarely a concern for TPUL family devices, however, the power consumption and thermal increase can be calculated using the steps provided in the application report, *CMOS Power Consumption* and *Cpd Calculation*.

#### 8.2.3 Application Curves

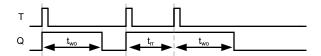


Figure 8-3. Output Pulse Timing Diagram



## 8.3 Typical Application - Delayed Pulse Generator

In this application, the TPUL2T323 is used to produce a delayed output pulse from a rising edge input trigger. The circuit configuration is shown in Figure 8-4.

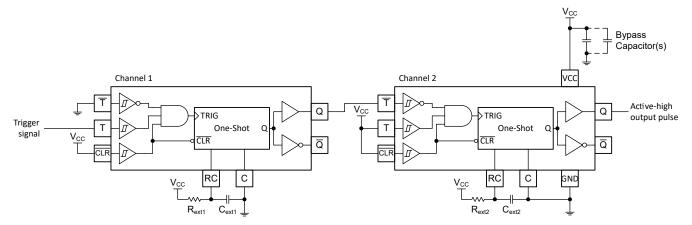


Figure 8-4. Delayed Pulse Generation Schematic Using the TPUL2T323

### 8.3.1 Application Curves

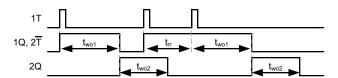


Figure 8-5. Output Pulse Timing Diagram

### 8.4 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating listed in the *Recommended Operating Conditions*.

During startup, the power supply should ramp within the provided power-up ramp rate range in the *Recommended Operating Conditions* table.

Each  $V_{CC}$  terminal must have a good bypass capacitor to prevent power disturbance. For normal operation of the TPUL2T323, a 0.1µF bypass capacitor is recommended. To reject different frequencies of noise, use multiple bypass capacitors in parallel. Capacitors with values of 0.1µF and 1µF are commonly used in parallel.

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#### 8.5 Layout

#### 8.5.1 Layout Guidelines

- Timing component placement
  - Place near the device
  - Provide an electrically short path to the device terminal connections
- Bypass capacitor placement
  - Place near the positive supply terminal of the device
  - Provide an electrically short ground return path
  - Use wide traces to minimize impedance
  - Keep the device, capacitors, and traces on the same side of the board whenever possible
- Signal trace geometry
  - 8mil to 12mil trace width
  - Lengths less than 12cm to minimize transmission line effects
  - Avoid 90° corners for signal traces
  - Use an unbroken ground plane below signal traces
  - Flood fill areas around signal traces with ground
  - For traces longer than 12cm
    - · Use impedance controlled traces
    - · Source-terminate using a series damping resistor near the output
    - · Avoid branches; buffer signals that must branch separately

### 8.5.2 Layout Example

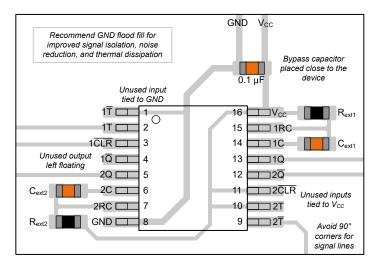


Figure 8-6. Layout Example for TPUL2T323 in the PW (TSSOP) package



## 9 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

### 9.1 Documentation Support

#### 9.1.1 Related Documentation

For related documentation, see the following:

- Texas Instruments, CMOS Power Consumption and Cpd Calculation application note
- Texas Instruments, Designing With Logic application note
- Texas Instruments, Thermal Characteristics of Standard Linear and Logic (SLL) Packages and Devices application note

### 9.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on Notifications to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 9.3 Support Resources

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 9.4 Trademarks

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#### 9.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 9.6 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

### 10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

### Changes from Revision \* (April 2025) to Revision A (September 2025)

### 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

Product Folder Links: TPUL2T323

www.ti.com

16-Oct-2025

#### PACKAGING INFORMATION

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	<b>RoHS</b> (3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
PTPUL2T323PWR	Active	Preproduction	TSSOP (PW)   16	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
PTPUL2T323PWR.A	Active	Preproduction	TSSOP (PW)   16	3000   LARGE T&R	-	Call TI	Call TI	-40 to 125	
TPUL2T323PWR	Active	Production	TSSOP (PW)   16	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 125	T2T323

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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#### OTHER QUALIFIED VERSIONS OF TPUL2T323:

Automotive: TPUL2T323-Q1

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

<sup>(4)</sup> Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.



# **PACKAGE OPTION ADDENDUM**

www.ti.com 16-Oct-2025

ไดเ	ΓF·	Qualified	1 Version	Definitions

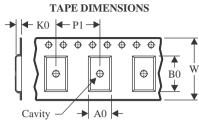
• Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 17-Oct-2025

### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

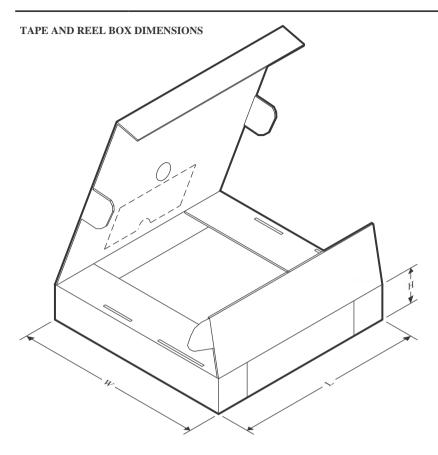


#### \*All dimensions are nominal

Device	U	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPUL2T323PWR	TSSOP	PW	16	3000	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1

PACKAGE MATERIALS INFORMATION

www.ti.com 17-Oct-2025

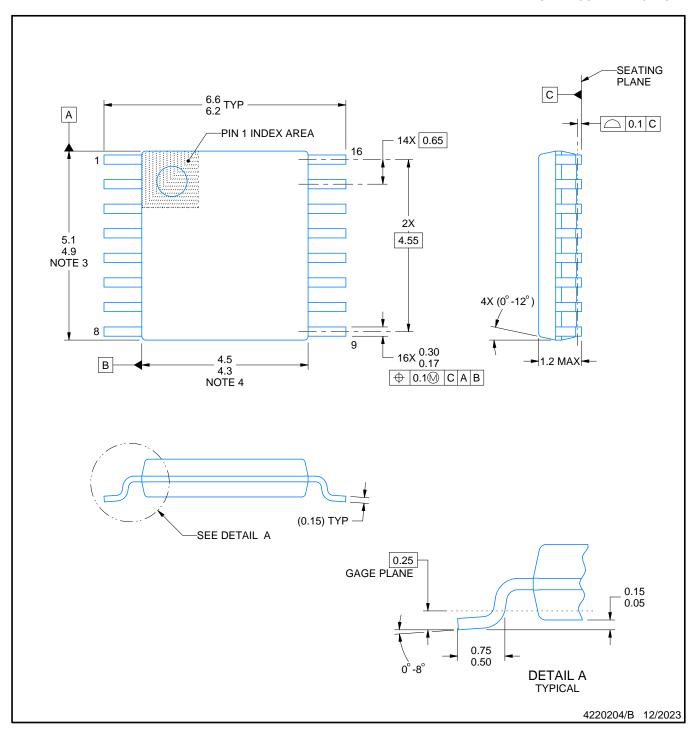


### \*All dimensions are nominal

Ì	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
ı	TPUL2T323PWR	TSSOP	PW	16	3000	353.0	353.0	32.0



SMALL OUTLINE PACKAGE



#### NOTES:

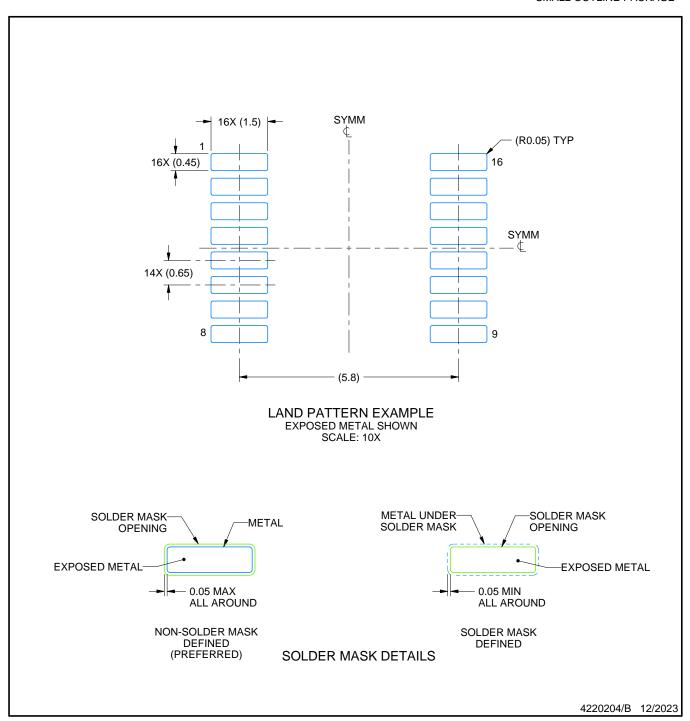
- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE

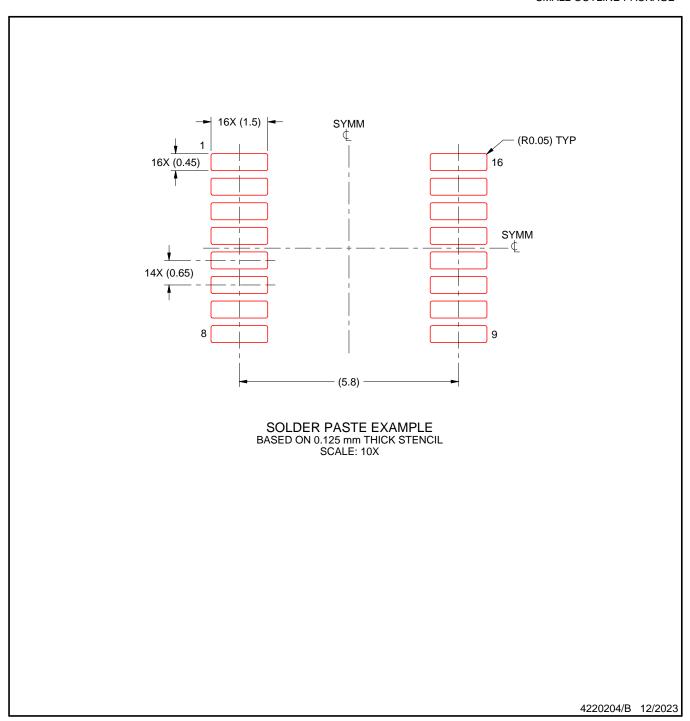


NOTES: (continued)

- 6. Publication IPC-7351 may have alternate designs.
- 7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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